



Click [here](#) for the 3D model.

General Information

Series	Array Auto COG Flex
Style	SMD Array
Description	SMD, MLCC, Array, Flex Termination, Automotive Grade
Features	Automotive Grade
RoHS	Yes
Termination	Flexible Termination
Qualifications	AEC-Q200
AEC-Q200	Yes
Chip Size	0612
MSL	1

Dimensions

L	1.6mm +/-0.2mm
W	3.2mm +/-0.2mm
T	0.8mm +/-0.10mm
P	0.8mm +/-0.10mm

Packaging Specifications

Packaging	T&R, 180mm, Paper Tape
Packaging Quantity	4000

Specifications

Capacitance	33 pF
Tolerance	5%
Voltage DC	16 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Insulation Resistance	100 GOhms